



100kHz, Rail-to-Rail I/O CMOS Operational Amplifier

1 FEATURES

• Gain Bandwidth: 100kHz

 Rail-to-Rail Input and Output ±0.6mV Max Vos

 Input Voltage Range: -0.2V to +5.7V with Vs = 5.5V

Supply Range: +2.6V to +5.5V

Specified Up to +125°C

Micro Size Packages: SOT23-5, SC70-5

2 APPLICATIONS

- Sensors
- Photodiode Amplification
- Active Filters
- Test Equipment
- Driving A/D Converters

3 DESCRIPTIONS

The RS121P/RS121BP families of products offer low voltage operation and rail-to-rail input and output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (100kHz) and slew rate of $0.04V/\mu s$. The op-amps are unity gain stable and feature an ultra-low input bias current.

The RS121P/RS121BP families of operational amplifiers are specified at the full temperature range of -40°C to 125°C under single or dual power supplies of 2.6V to 5.5V.

Device Information (1)

| PART NUMBER | PACKAGE | BODY SIZE (NOM) | |
|-------------|---------|-----------------|--|
| RS121P | SOT23-5 | 2.90mm×1.60mm | |
| RS121P | SC70-5 | 2.10mm×1.25mm | |
| RS121BP | SC70-5 | 2.10mm×1.25mm | |

⁽¹⁾ For all available packages, see the orderable addendum at the end of the data sheet.



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4 REVISION HISTORY

Note: Page numbers for previous revisions may different from page numbers in the current version.

| Version | Change Date | Change Item |
|---------|-------------|--|
| B.1 | 2022/11/24 | Update Package Qty on Page 6 in RevA.6 Delete RS121PXK, RS121BPXF, RS121BPXC5, RS121PXM, RS122PXTDC8, RS121PXTDE8 Orderable Device Add TAPE AND REEL INFORMATION |
| B.1.1 | 2024/03/01 | Modify packaging naming |
| B.2 | 2024/06/21 | 1. Add MSL on Page 4 in RevB.1.1 2. Update PACKAGE note 3. Add RS121BPXC5 Orderable Device on Page 4 in RevB.1.1 |
| B.3 | 2024/12/18 | Delete RS122PXK/RS122PXM/RS124PXP/RS124PXQ Orderable Device Delete content related to RS122P and RS124P Change the product name to: RS121P RS121BP |



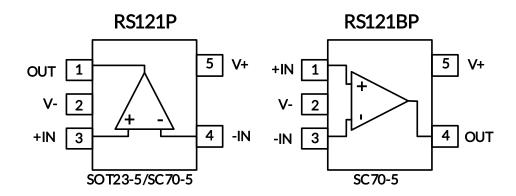
5 PACKAGE/ORDERING INFORMATION (1)

| Orderable Device | Package Type | Pin | Channel | Op Temp(°C) | Device Marking ⁽²⁾ | MSL (3) | Package Qty |
|---------------------|--------------|-----|---------|--------------|----------------------------------|---------|---------------------|
| RS121PXF | SOT23-5 | 5 | 1 | -40°C ~125°C | 121P | MSL3 | Tape and Reel, 3000 |
| RS121PXC5 | SC70-5 (4) | 5 | 1 | -40°C ~125°C | 121P | MSL3 | Tape and Reel, 3000 |
| RS121BPXC5 | SC70-5 (4) | 5 | 1 | -40°C ~125°C | 121BP | MSL3 | Tape and Reel, 3000 |

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (3) RUNIC classify the MSL level with using the common preconditioning setting in our assembly factory conforming to the JEDEC industrial standard J-STD-20F. Please align with RUNIC if your end application is quite critical to the preconditioning setting or if you have special requirement.
- (4) Equivalent to SOT353.



6 PIN CONFIGURATION AND FUNCTIONS



PIN DESCRIPTION

| | PIN | | | | | | |
|------|----------------|---------|---------|---------------------------------|--|--|--|
| NAME | RS121P | RS121BP | I/O (1) | DESCRIPTION | | | |
| | SOT23-5/SC70-5 | SC70-5 | | | | | |
| -IN | 4 | 3 | I | Negative (inverting) input | | | |
| +IN | 3 | 1 | I | Positive (noninverting) input | | | |
| OUT | 1 | 4 | 0 | Output | | | |
| V- | 2 | 2 | - | Negative (lowest) power supply | | | |
| V+ | 5 | 5 | - | Positive (highest) power supply | | | |

⁽¹⁾ I = Input, O = Output.



7 SPECIFICATIONS

7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) (1)

| | | | MIN | MAX | UNIT | |
|---------------|---|---------|----------|-----------|--------|--|
| | Supply, Vs=(V+) - (V-) | | 7 | | | |
| Voltage | Signal input pin (2) | | (V-)-0.5 | (V+) +0.5 | V | |
| | Signal output pin (3) | | (V-)-0.5 | (V+) +0.5 | 1 | |
| | Signal input pin ⁽²⁾ | -10 10 | | mA | | |
| Current | Signal output pin (3) | -55 | 55 | mA | | |
| Current | Output short-circuit (4) | Conti | | | | |
| 0 | D-1 (5) | SOT23-5 | | 230 | 96 /// | |
| θ_{JA} | Package thermal impedance (5) | SC70-5 | | 380 | °C/W | |
| | Operating range, T _A | -40 | 125 | | | |
| Temperature | Junction, T _J ⁽⁶⁾ | -40 | 150 | °C | | |
| | Storage, T _{stg} | -65 | 150 | 1 | | |

⁽¹⁾ Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

- (4) Short-circuit to ground, one amplifier per package.
- (5) The package thermal impedance is calculated in accordance with JESD-51.
- (6) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

7.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

| | | _ | | VALUE | UNIT |
|--------|-------------------------|--------------------|--|-------|------|
| | M | | Human-Body Model (HBM), per ANSI/ESDA/JEDEC JS-001 (1) | ±3000 | \ / |
| V(ESD) | Electrostatic discharge | Machine Model (MM) | ±200 | V | |

⁽¹⁾ JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

7.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

| | | MIN | МОМ | MAX | UNIT |
|-------------------------------------|---------------|------|-----|-------|------|
| Supply valtage V (V.) (V.) | Single-supply | 2.6 | | 5.5 | \/ |
| Supply voltage, $V_S = (V+) - (V-)$ | Dual-supply | ±1.3 | | ±2.75 | V |

⁽²⁾ Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.

⁽³⁾ Output terminals are diode-clamped to the power-supply rails. Output signals that can swing more than 0.5V beyond the supply rails should be current-limited to ±55mA or less.



7.4 Electrical Characteristics

(At $T_A = +25^{\circ}$ C, $V_S = 5V$, $R_1 = 10$ k Ω connected to $V_S/2$, and $V_{OUT} = V_S/2$. Full $^{(9)} = -40^{\circ}$ C to $+125^{\circ}$ C, unless otherwise noted.) $^{(1)}$

| | DADANAFTED | COMPLETIONS | - | | RS121P | /RS121BI | • |
|----------------|------------------------------------|---|------|--------------------|----------------|--------------------|----------|
| | PARAMETER | CONDITIONS | Tı | MIN ⁽²⁾ | TYP (3) | MAX ⁽²⁾ | UNIT |
| POWER | RSUPPLY | | | | | | |
| Vs | Operating Voltage Range | | 25°C | 2.6 | | 5.5 | V |
| ΙQ | Quiescent Current Per Amplifier | | 25°C | 4 | 7.6 | 11 | μΑ |
| PSRR | Power-Supply Rejection Ratio | V _S =2.6V to 5.5V, | 25°C | 70 | 76 | | dB |
| PSKK | Power-Supply Rejection Ratio | V _{CM} =(V-)+0.5V | Full | 60 | | | иь |
| ton | Turn-on Time | | 25°C | | 140 | | μs |
| INPUT | | | | | | | |
| Vos | Input Offset Voltage | V _{CM} = V _S /2 | 25°C | -0.6 | ±0.2 | 0.6 | mV |
| Vos Tc | Input Offset Voltage Average Drift | | Full | | ±2.5 | | μV/°C |
| IB | Input Bias Current (4) (5) | | 25°C | | ±1 | ±10 | pА |
| los | Input Offset Current (4) | | 25°C | | ±1 | ±10 | pА |
| Vсм | Common-Mode Voltage Range | V _S = 5.5V | 25°C | -0.2 | | 5.7 | V |
| | | V _S = 5.5V, | 25°C | 73 | 79 | | dB |
| CNADD | C M D : 1: D !: | V _{CM} =-0.2V to 4V | Full | 67 | | | |
| CMRR | Common-Mode Rejection Ratio | V _S = 5.5V, | 25°C | 64 | 80 | | |
| | | V _{CM} =-0.2V to 5.7V | Full | 57 | | | |
| OUTPU | т | | | | | | |
| | | R _L =2KΩ, | 25°C | 93 | 104 | | |
| Λ | | Vo=0.15V to 4.85V | Full | 83 | | | dB |
| Aol | Open-Loop Voltage Gain | R _L =10KΩ, | 25°C | 90 | 96 | | |
| | | Vo= 0.05V to 4.95V | Full | 80 | | | |
| | Output Swing from Pail | R _L =2KΩ | 25°C | | 40 | 50 | mV |
| | Output Swing from Rail | R _L =10KΩ | 25°C | | 10 | 20 | mv |
| Іоит | Output Current Source (6) (7) | | 25°C | | 35 | | mA |
| FREQUI | ENCY RESPONSE | | | | | | |
| SR | Slew Rate (8) | | 25°C | | 0.04 | | V/μs |
| GBP | Gain-Bandwidth Product | | 25°C | | 100 | | KHz |
| PM | Phase Margin | | 25°C | | 62 | | 0 |
| ts | Settling Time, 0.1% | | 25°C | | 90 | | μs |
| | Overload Recovery Time | V _{IN} •Gain≥V _S , G=-100 | 25°C | | 90 | | μs |
| NOISE | | | | | | | |
| 0 | Input Voltage Noise Density | f = 1KHz | 25°C | | 98 | | nV/√Hz |
| e _n | Input Voltage Noise Density | f = 10KHz | 25°C | | 53 | | nV/√Hz |



- (1) Electrical table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device.
- (2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.
- (3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.
- (4) This parameter is ensured by design and/or characterization and is not tested in production.
- (5) Positive current corresponds to current flowing into the device.
- (6) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.
- (7) Short circuit test is a momentary test.
- (8) Number specified is the slower of positive and negative slew rates.
- (9) Specified by characterization only.



7.5 Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At $T_A = +25$ °C, $V_S = 5V$, $R_L = 10k\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

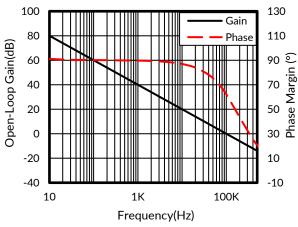


Figure 1. Open-loop Gain and Phase vs Frequency

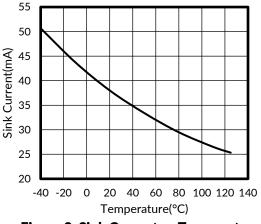


Figure 3. Sink Current vs Temperature

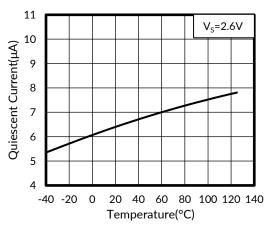


Figure 5. Quiescent Current vs Temperature

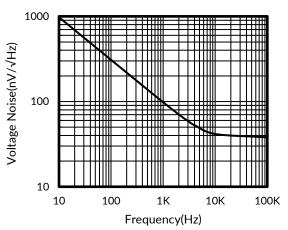


Figure 2. Input Voltage Noise Spectral Density vs Frequency

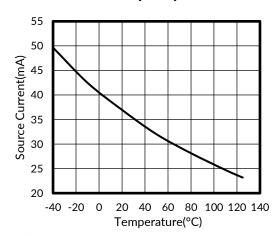


Figure 4. Source Current vs Temperature

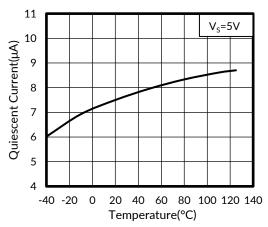


Figure 6. Quiescent Current vs Temperature



Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At T_A = +25°C, V_S =5V, R_L = 10k Ω connected to $V_S/2$, V_{OUT} = $V_S/2$, unless otherwise noted.

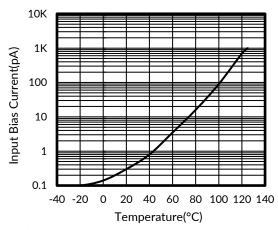


Figure 7. Input Bias Current vs Temperature

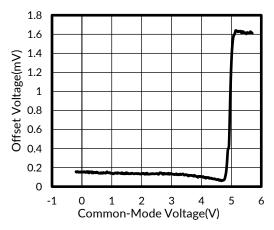


Figure 9. Offset Voltage vs Common-Mode Voltage

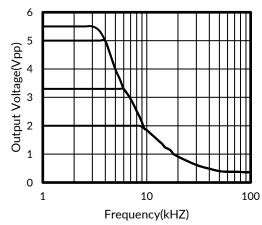


Figure 11. Maximum Output Voltage vs Frequency

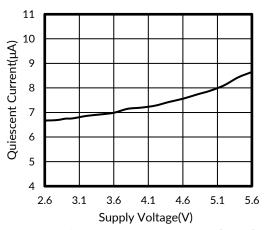


Figure 8. Quiescent Current vs Supply Voltage

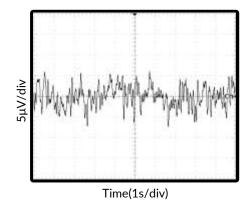


Figure 10. 0.1Hz to 10Hz Input Voltage Noise

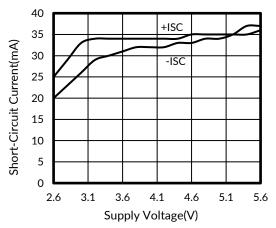


Figure 12. Power Supply Voltage vs Short Circuit Current



Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At T_A = +25°C, V_S =5V, R_L = 10k Ω connected to $V_S/2$, V_{OUT} = $V_S/2$, unless otherwise noted.

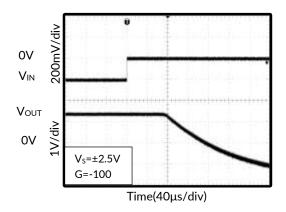


Figure 13. Positive Overload Recovery

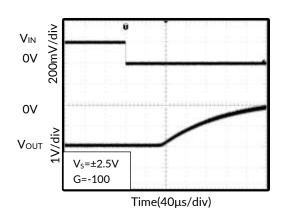


Figure 14. Negative Overload Recovery

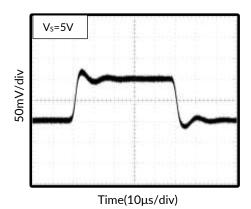


Figure 15. Small-signal Step Response

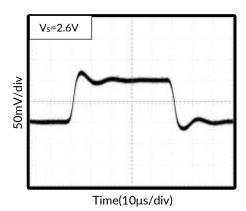


Figure 16. Small-signal Step Response

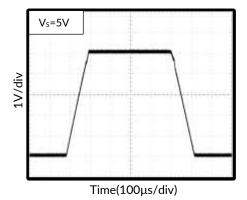


Figure 17. Large-signal Step Response

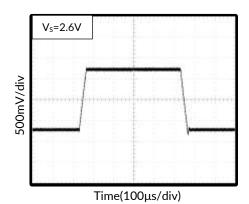


Figure 18. Large-signal Step Response



Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At T_A = +25°C, V_S =5V, R_L = 10k Ω connected to $V_S/2$, V_{OUT} = $V_S/2$, unless otherwise noted.

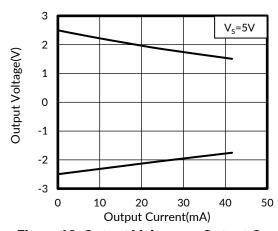


Figure 19. Output Voltage vs Output Current

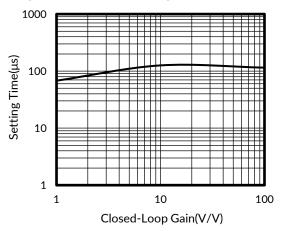


Figure 21. Setting Time vs Closed-loop Gain

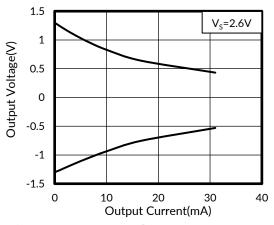


Figure 20. Output Voltage vs Output Current

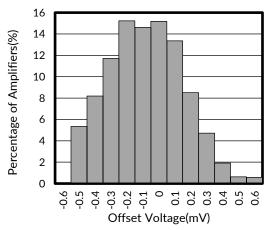


Figure 22. Offset Voltage Production Distribution



8 DETAILED DESCRIPTION

8.1 Overview

The RS121P/RS121BP devices are unity-gain stable, single channel op amps with low noise and distortion. The device consists of a low noise input stage with a folded cascade and a rail-to-rail output stage. This topology exhibits superior noise and distortion performance across a wide range of supply voltages that are not delivered by legacy commodity audio operational amplifiers.

8.2 Phase Reversal Protection

The RS121P/RS121BP family has internal phase-reversal protection. Many op amps exhibit phase reversal when the input is driven beyond the linear common-mode range. This condition is most often encountered in noninverting circuits when the input is driven beyond the specified common-mode voltage range, causing the output to reverse into the opposite rail. The input of the RS121P/RS121BP prevents phase reversal with excessive common-mode voltage. Instead, the appropriate rail limits the output voltage. This performance is shown in figure 23.

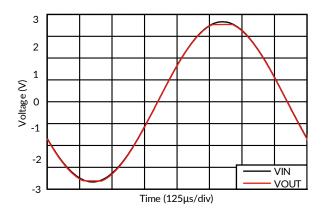


Figure 23. Output Waveform Devoid of Phase Reversal During an Input Overdrive Condition

8.3 EMI Rejection Ratio (EMIRR)

The electromagnetic interference (EMI) rejection ratio, or EMIRR, describes the EMI immunity of operational amplifiers. An adverse effect that is common to many operational amplifiers is a change in the offset voltage as a result of RF signal rectification. An operational amplifier that is more efficient at rejecting this change in offset as a result of EMI has a higher EMIRR and is quantified by a decibel value. Measuring EMIRR can be performed in many ways, but this document provides the EMIRR IN+, which specifically describes the EMIRR performance when the RF signal is applied to the noninverting input pin of the operational amplifier. In general, only the noninverting input is tested for EMIRR for the following three reasons:

- Operational amplifier input pins are known to be the most sensitive to EMI, and typically rectify RF signals better than the supply or output pins.
- The noninverting and inverting operational amplifier inputs have symmetrical physical layouts and exhibit nearly matching EMIRR performance.
- EMIRR is easier to measure on noninverting pins than on other pins because the noninverting input pin can be isolated on a printed-circuit-board (PCB). This isolation allows the RF signal to be applied directly to the noninverting input pin with no complex interactions from other components or connecting PCB traces.



DETAILED DESCRIPTION (continued)

The EMIRR IN+ of the RS121P/RS121BP is plotted versus frequency in Figure 24. If available, any dual and quad operational amplifier device versions have approximately identical EMIRR IN+ performance. The RS121P/RS121BP unity-gain bandwidth is 100 kHz. EMIRR performance below this frequency denotes interfering signals that fall within the operational amplifier bandwidth.

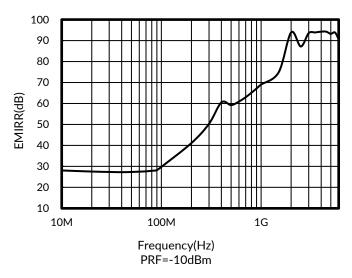


Figure 24. RS121P/RS121BP EMIRR vs Frequency

8.4 EMIRR IN+ Test Configuration

Figure 25 shows the circuit configuration for testing the EMIRR IN+. An RF source is connected to the operational amplifier noninverting input pin using a transmission line. The operational amplifier is configured in a unity-gain buffer topology with the output connected to a low-pass filter (LPF) and a digital multimeter (DMM). A large impedance mismatch at the operational amplifier input causes a voltage reflection; however, this effect is characterized and accounted for when determining the EMIRR IN+. The resulting dc offset voltage is sampled and measured by the multimeter. The LPF isolates the multimeter from residual RF signals that can interfere with multimeter accuracy.

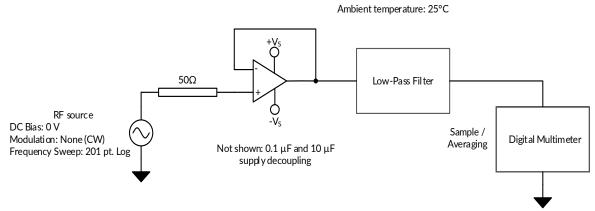


Figure 25. EMIRR IN+ Test Configuration Schematic



9 APPLICATION AND IMPLEMENTATION

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Note

The RS121P/RS121BP are high precision, rail-to-rail operational amplifiers that can be run from a single-supply voltage 2.6V to 5.5V (± 1.3 V to ± 2.75 V). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier. Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications. Good layout practice mandates use of a 0.1μ F capacitor place closely across the supply pins.

9.2 25-kHz Low-pass Filter

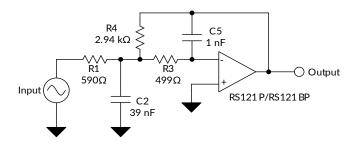


Figure 26. 25-kHz Low-Pass Filter

9.3 Design Requirements

Low-pass filters are commonly employed in signal processing applications to reduce noise and prevent aliasing. The RS121P/RS121BP devices are ideally suited to construct high-speed, high-precision active filters. Figure 26 shows a second-order, low-pass filter commonly encountered in signal processing applications.

Use the following parameters for this design example:

- Gain = 5 V/V (inverting gain)
- Low-pass cutoff frequency = 25 kHz
- Second-order Chebyshev filter response with 3-dB gain peaking in the passband

9.4 Detailed Design Procedure

The infinite-gain multiple-feedback circuit for a low-pass network function is shown in Figure 26. Use Equation 1 to calculate the voltage transfer function.

$$\frac{\text{Output}}{\text{Input}}(s) = \frac{-1/R_1R_3C_2C_5}{s^2 + (s/C_2) + (1/R_1 + 1/R_3 + 1/R_4) + 1/R_3R_4C_2C_5}$$
(1)

This circuit produces a signal inversion. For this circuit, the gain at dc and the low-pass cutoff frequency are calculated by Equation 2:

Gain =
$$\frac{R_4}{R_1}$$

 $f_c = \frac{1}{2\pi} \sqrt{(1/R_3 R_4 C_2 C_5)}$ (2)



9.5 Application Curve

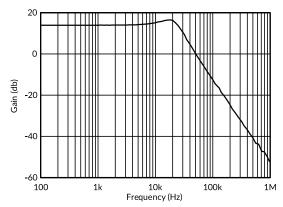


Figure 27. Low-Pass Filter Transfer Function



10 LAYOUT

10.1 Layout Guidelines

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a $0.1\mu F$ capacitor closely across the supply pins.

These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.

10.2 Layout Example

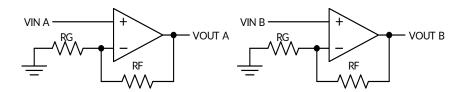


Figure 28. Schematic Representation

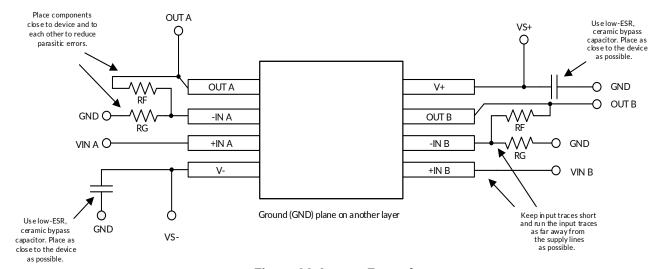
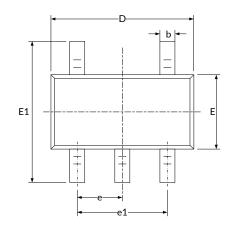


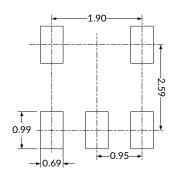
Figure 29. Layout Example

NOTE: Layout Recommendations have been shown for dual op-amp only, follow similar precautions for Single and four.

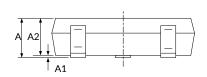


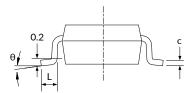
11 PACKAGE OUTLINE DIMENSIONS SOT23-5 (3)





RECOMMENDED LAND PATTERN (Unit: mm)



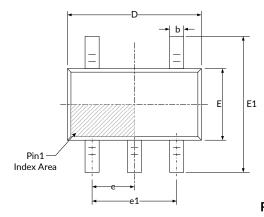


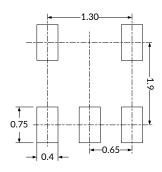
| S. mahal | Dimensions I | n Millimeters | Dimensions In Inches | | | |
|----------|---------------|---------------|----------------------|----------|--|--|
| Symbol | Min | Мах | Min | Max | | |
| A (1) | 1.050 | 1.250 | 0.041 | 0.049 | | |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 | | |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 | | |
| b | 0.300 | 0.500 0.012 | | 0.020 | | |
| С | 0.100 | 0.200 | 0.004 | 0.008 | | |
| D (1) | (1) 2.820 3.0 | | 0.111 | 0.119 | | |
| E (1) | 1.500 | 1.700 | 0.059 | 0.067 | | |
| E1 | 2.650 | 2.950 | 0.104 | 0.116 | | |
| е | 0.950(| BSC) (2) | 0.037(| BSC) (2) | | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 | | |
| L | 0.300 | 0.600 | 0.012 | 0.024 | | |
| θ | 0° | 8° | 0° | 8° | | |

- Plastic or metal protrusions of 0.15mm maximum per side are not included.
 BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
- 3. This drawing is subject to change without notice.

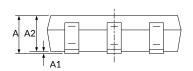


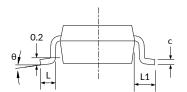
SC70-5 (3)





RECOMMENDED LAND PATTERN (Unit: mm)





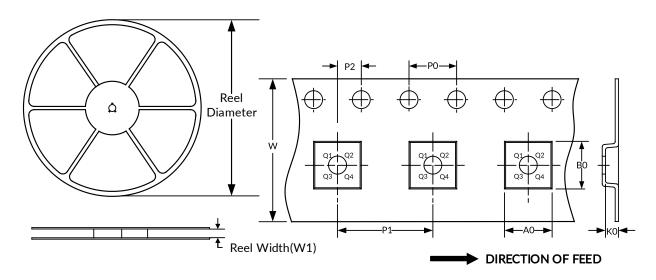
| Constant | Dimensions I | n Millimeters | Dimension | s In Inches |
|----------|--------------|---------------|----------------|-------------|
| Symbol | Min | Max | Min | Max |
| A (1) | 0.900 | 1.100 | 0.035 | 0.043 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 0.900 | 1.000 | 0.035 | 0.039 |
| b | 0.150 | 0.350 | 0.006 | 0.014 |
| С | 0.080 | 0.150 | 0.003 0.079 | 0.006 |
| D (1) | 2.000 | 2.200 | | 0.087 |
| E (1) | 1.150 | 1.350 | 0.045 | 0.053 |
| E1 | 2.150 | 2.450 | 0.085 | 0.096 |
| е | 0.650(| BSC) (2) | 0.026(| BSC) (2) |
| e1 | 1.300(| BSC) (2) | 0.051(| BSC) (2) |
| L | 0.260 | 0.260 0.460 | | 0.018 |
| L1 | 0.5 | 0.525 | |)21 |
| θ | 0° | 8° | 0° | 8° |

- 1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
- 2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.3. This drawing is subject to change without notice.



12 TAPE AND REEL INFORMATION REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

| Package Type | Reel Diameter | Reel Width(mm) | A0 (mm) | B0 (mm) | K0 (mm) | P0 (mm) | P1 (mm) | P2 (mm) | W (mm) | Pin1 Quadrant |
|--------------|------------------|-------------------|------------|------------|------------|------------|------------|------------|-----------|------------------|
| SOT23-5 | 7" | 9.5 | 3.20 | 3.20 | 1.40 | 4.0 | 4.0 | 2.0 | 8.0 | Q3 |
| SC70-5 | 7" | 9.5 | 2.25 | 2.55 | 1.20 | 4.0 | 4.0 | 2.0 | 8.0 | Q3 |

- 1. All dimensions are nominal.
- 2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



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